

P-Channel 30 V (D-S) MOSFET



FEATURES

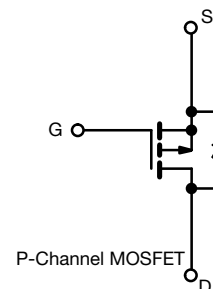
- TrenchFET® Gen III p-channel power MOSFET
- 100% R_g tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Adapter switch
- Load switch
- Power management in battery-operated, mobile and wearable devices



PRODUCT SUMMARY	
V_{DS} (V)	-30
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -10$ V	0.0079
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5$ V	0.0108
Q_g typ. (nC)	44
I_D (A)	-16 ^{a, e}
Configuration	Single

ORDERING INFORMATION	
Package	SO-8
Lead (Pb)-free and halogen-free	Si4103DY-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage	V_{DS}	-30	V	
Gate-source voltage	V_{GS}	± 20		
Continuous drain current ($T_J = 150$ °C)	$T_C = 25$ °C	-16 ^a	A	
	$T_C = 70$ °C	-16 ^a		
	$T_A = 25$ °C	-14 ^{b, c}		
	$T_A = 70$ °C	-11.3 ^{b, c}		
Pulsed drain current ($t = 100$ μ s)	I_{DM}	-80 ^a		
Continuous source-drain diode current	$T_C = 25$ °C	-4.3		
	$T_A = 70$ °C	-2.1 ^{b, c}		
Maximum power dissipation	$T_C = 25$ °C	5.2	W	
	$T_C = 70$ °C	3.3		
	$T_A = 25$ °C	2.5 ^{b, c}		
	$T_A = 70$ °C	1.6 ^{b, c}		
Operating junction and storage temperature range	T_J, T_{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature)		260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^{b, d}	$t \leq 10$ s	R_{thJA}	40	50	°C/W
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	20	24	

Notes

- Package limited
- Surface mounted on 1" x 1" FR4 board
- $t = 10$ s
- Maximum under steady state conditions is 85 °C/W
- $T_C = 25$ °C

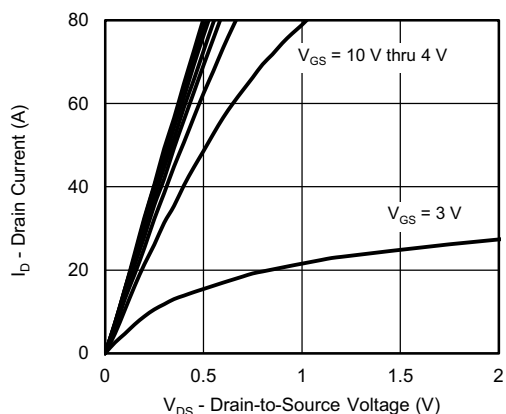
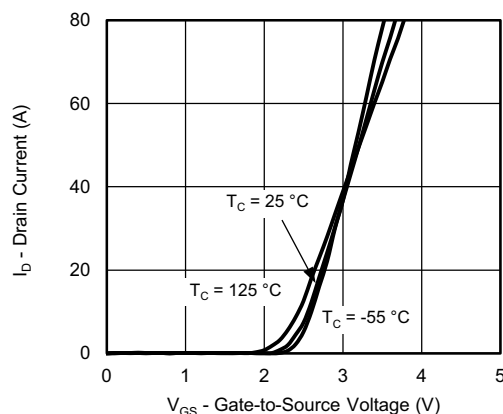
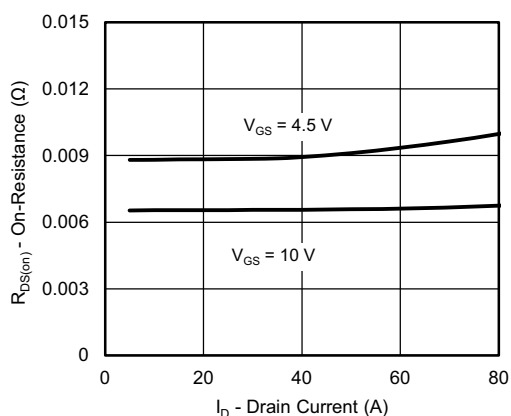
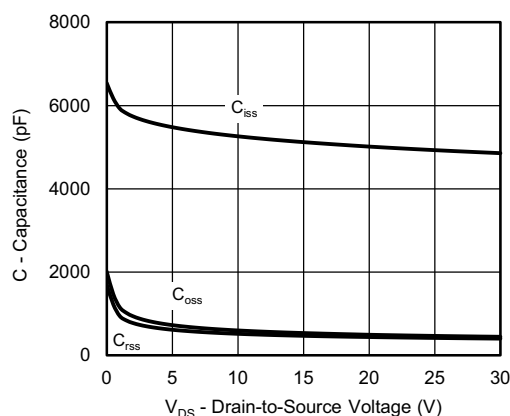
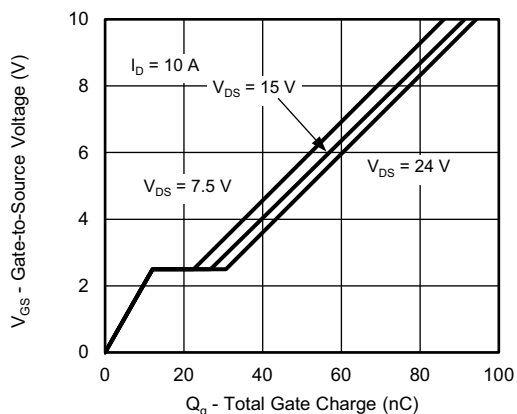
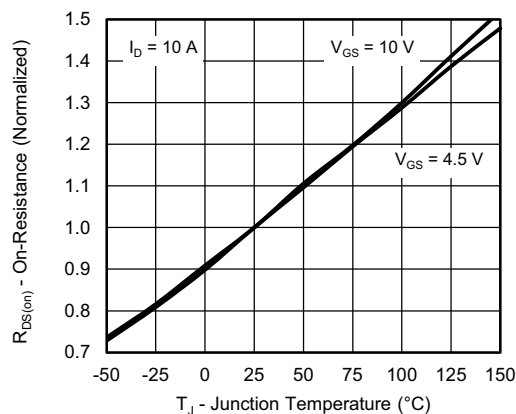


SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-30	-	-	V
V _{DS} temperature coefficient	ΔV _{DS} /T _J	I _D = -250 μA	-	-23	-	mV/°C
V _{GS(th)} temperature coefficient	ΔV _{GS(th)} /T _J		-	5	-	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA	-1	-	-2	V
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V	-	-	-1	μA
		V _{DS} = -30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-10	
On-state drain current ^a	I _{D(on)}	V _{DS} ≤ -5 V, V _{GS} = 0 V	-5	-	-	A
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V, I _D = -10 A	-	0.0067	0.0079	Ω
		V _{GS} = -4.5 V, I _D = -5 A	-	0.0090	0.0108	
Forward transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -20 A	-	60	-	S
Dynamic ^b						
Input capacitance	C _{iss}	V _{DS} = -15 V, V _{GS} = 0 V, f = 1 MHz	-	5200	-	pF
Output capacitance	C _{oss}		-	535	-	
Reverse transfer capacitance	C _{rss}		-	470	-	
Total gate charge	Q _g	V _{DS} = -15 V, V _{GS} = -10 V, I _D = -10 A	-	92	140	nC
		V _{DS} = -15 V, V _{GS} = -4.5 V, I _D = -10 A	-	44	66	
Gate-source charge	Q _{gs}	V _{DS} = -15 V, V _{GS} = -4.5 V, I _D = -10 A	-	12.1	-	
Gate-drain charge	Q _{gd}		-	14.8	-	
Gate resistance	R _g	f = 1 MHz	0.8	3.8	7.6	Ω
Turn-on delay time	t _{d(on)}	V _{DD} = -15 V, R _L = 3 Ω, I _D ≅ -5 A, V _{GEN} = -4.5 V, R _g = 1 Ω	-	57	120	ns
Rise time	t _r		-	38	80	
Turn-off delay time	t _{d(off)}		-	55	110	
Fall time	t _f		-	28	60	
Turn-on delay time	t _{d(on)}	V _{DD} = -15 V, R _L = 3 Ω, I _D ≅ -5 A, V _{GEN} = -10 V, R _g = 1 Ω	-	11	20	
Rise time	t _r		-	17	35	
Turn-off delay time	t _{d(off)}		-	78	160	
Fall time	t _f		-	26	50	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-4.3	A
Pulse diode forward current	I _{SM}		-	-	-80	
Body diode voltage	V _{SD}	I _S = -5 A, V _{GS} = 0 V	-	-0.8	-1.2	V
Body diode reverse recovery time	t _{rr}	I _F = -5 A, di/dt = 100 A/μs, T _J = 25 °C	-	31	60	ns
Body diode reverse recovery charge	Q _{rr}		-	20	40	nC
Reverse recovery fall time	t _a		-	13	-	ns
Reverse recovery rise time	t _b		-	18	-	

Notes

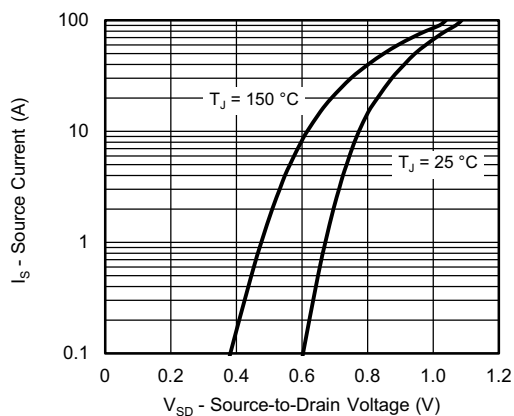
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

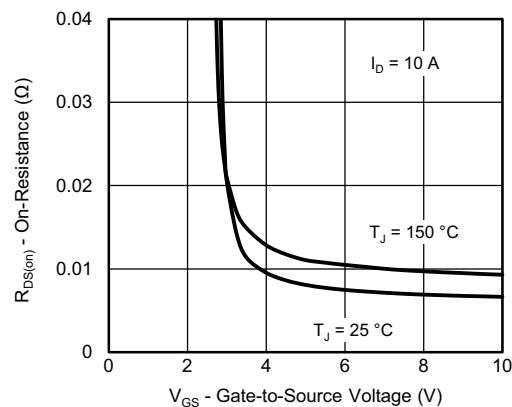
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Output Characteristics

Transfer Characteristics

On-Resistance vs. Drain Current and Gate Voltage

Capacitance

Gate Charge

On-Resistance vs. Junction Temperature



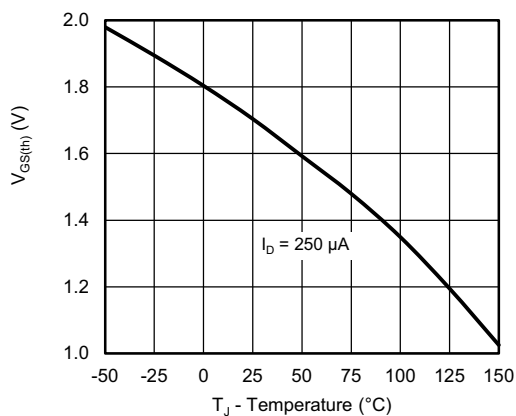
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



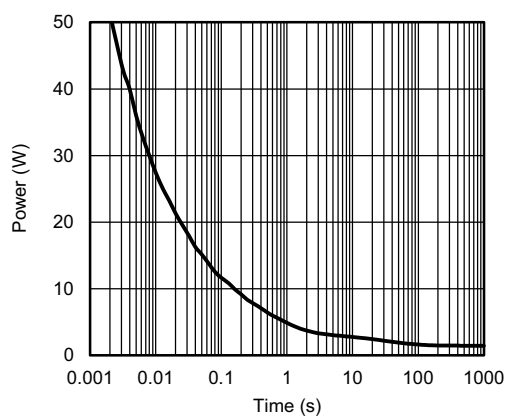
Source-Drain Diode Forward Voltage



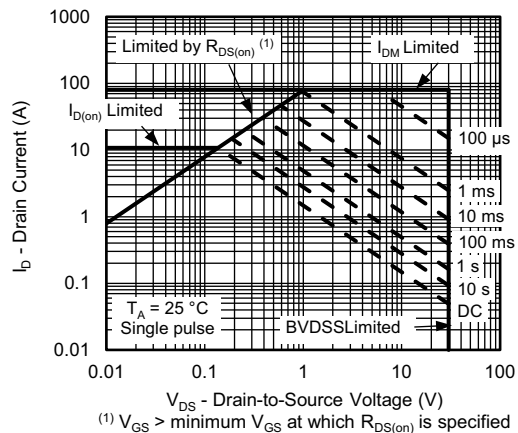
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



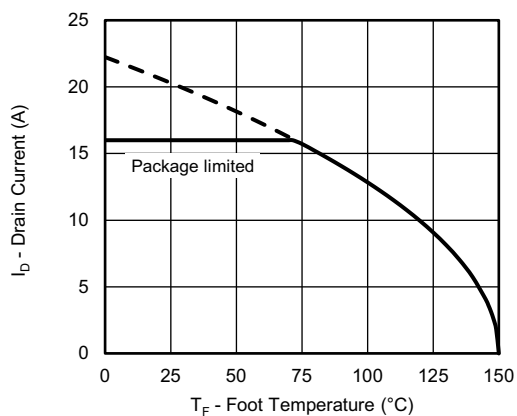
Single Pulse Power, Junction-to-Ambient



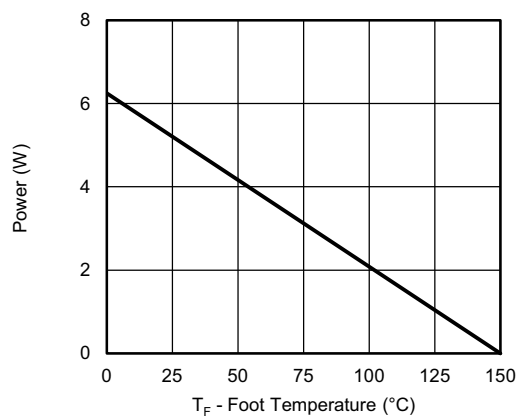
Safe Operating Area, Junction-to-Ambient



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a



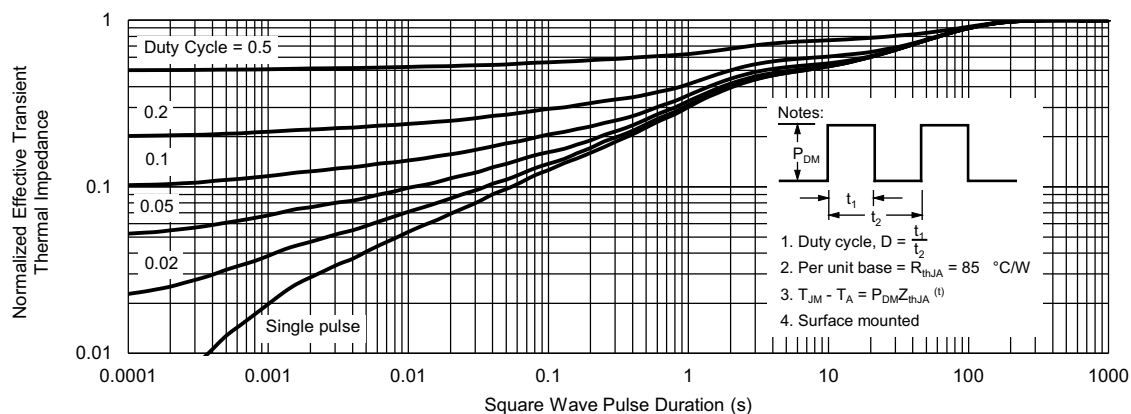
Power, Junction-to-Foot

Note

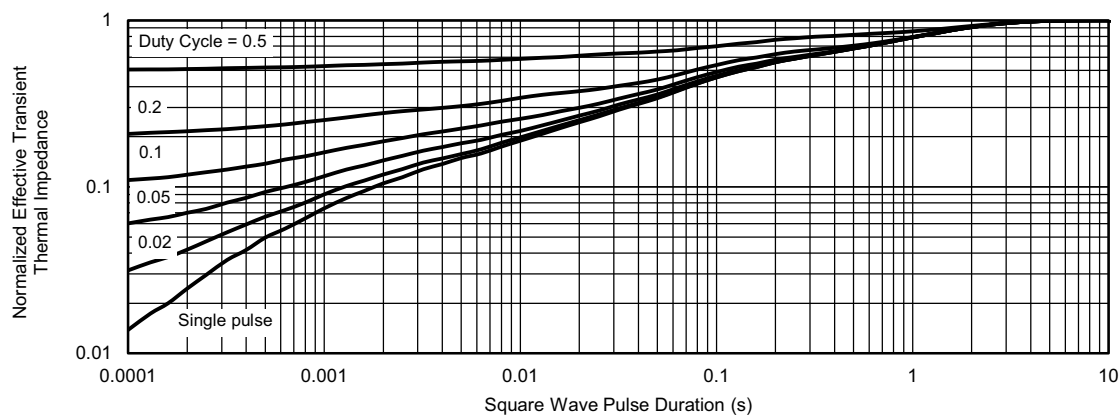
- a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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